



# **OKI Semiconductor**

**FEDR27T3202L-02-02**Issue Date: Jul. 11, 2005

# MR27T3202L

2M-Word x 16-Bit or 4M-Word x 8-Bit P2ROM

#### **FEATURES**

? 2,097,152-word  $\times$  16-bit / 4,194,304-word  $\times$  8-bit electrically switchable configuration

? Access time

2.7 V to 3.6 V power supply 90 ns MAX 3.0 V to 3.6 V power supply 80 ns MAX

? Operating current 20 mA MAX(5MHz)

? Standby current 10 킕 MAX

? Input/Output TTL compatible

? Three-state output

#### **PACKAGES**

? MR27T3202L-xxxMA
 44-pin plastic SOP (SOP44-P-600-1.27-K)
 ? MR27T3202L-xxxTN
 48-pin plastic TSOP (TSOP I 48-P-1220-0.50-1K)

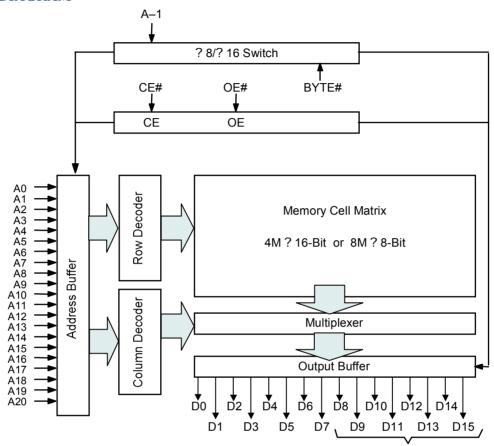
#### P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following;

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- · Custom Marking is available at no additional charge.
- Pin Compatible with Mask ROM and some FLASH products.

#### **PIN CONFIGURATION (TOP VIEW)** NC 1 44 A20 $\bigcirc$ 43 A19 A18 A17 42 A8 4 41 A9 Α7 40 A10 5 A6 Α5 6 39 A11 A4 38 A12 8 37 A13 А3 36 A14 35 A15 9 A2 Α1 A0 11 34 A16 33 BYTE# CE# V<sub>SS</sub> 13 32 V<sub>SS</sub> 31 D15/A-1 30 D7 14 OF# 15 D0 D8 16 29 D14 28 D6 27 D13 D1 17 18 D9 26 D5 25 D12 D2 19 20 D10 D3 21 24 D4 D11 22 23 V<sub>CC</sub> 44SOP 48 A16 A15 2 3 4 5 6 7 8 9 47 BYTE# A14 46 V<sub>SS</sub> 45 D15/A–1 A13 A12 44 D7 43 D14 A11 A10 42 D6 Α9 Α8 41 D13 40 D5 39 D12 38 D4 37 V<sub>CC</sub> A19 A20 NC 12 NC NC 36 D11 14 15 16 17 18 19 20 21 22 23 24 NC 35 D3 34 D10 33 D2 NC A18 A17 32 D9 31 D1 Α7 A6 30 D8 29 D0 28 OE# A5 A4 АЗ 27 V<sub>SS</sub> 26 CE# 25 A0 A2 Α1 48TSOP(Type-I)

# **BLOCK DIAGRAM**



In 8-bit output mode, these pins are placed in a high-Z state and pin D15 functions as the A-1 address pin.

# **PIN DESCRIPTIONS**

Pin name	Functions
D15 / A-1	Data output / Address input
A0 to A20	Address inputs
D0 to D14	Data outputs
CE#	Chip enable input
OE#	Output enable input
BYTE#	Word / Byte select input
Vcc	Power supply voltage
V <sub>SS</sub>	Ground
NC	No connect

# **FUNCTION TABLE**

Mode	CE#	OE#	BYTE#	Vcc	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	Н			D <sub>OUT</sub>	
Read (8-Bit)	L	L	L	071/	D <sub>OUT</sub>	Hi–Z	L/H
Output disable	L	Н	H L	2.7 V to 3.6 V		Hi–Z	*
Standby	Н	*	H L	3.0 V		Hi–Z	*

<sup>\*:</sup> Don't Care (H or L)

### **ABSOLUTE MAXIMUM RATINGS**

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	캜
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	Vı		–0.5 to V <sub>CC</sub> +0.5	V
Output voltage	Vo	relative to V <sub>SS</sub>	–0.5 to V <sub>CC</sub> +0.5	V
Power supply voltage	V <sub>CC</sub>		–0.5 to 5	V
Power dissipation per package	$P_D$	Ta = 25캜	1.0	W
Output short circuit current	los	_	10	mA

### RECOMMENDED OPERATING CONDITIONS

(Ta = 0 to 70캜)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V <sub>CC</sub> power supply voltage	Vcc		2.7	_	3.6	V
Input "H" level	V <sub>IH</sub>	$V_{CC} = 2.7 \text{ to } 3.6 \text{ V}$	2.2	_	V <sub>CC</sub> +0.5*	V
Input "L" level	$V_{IL}$		-0.5**	_	0.6	V

Voltage is relative to  $V_{SS}$ .

\* : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

### PIN CAPACITANCE

 $(V_{CC} = 3.0 \text{ V}, \text{ Ta} = 25 캜, f = 1 \text{ MHz})$ 

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C <sub>IN1</sub>	V <sub>1</sub> = 0 V	_	_	10	
BYTE#	C <sub>IN2</sub>	V	_	_	200	pF
Output	Соит	V <sub>O</sub> = 0 V	_	_	10	

<sup>\*\*: -1.5</sup>V(Min.) when pulse width of undershoot is less than 10ns.

# **ELECTRICAL CHARACTERISTICS**

### **DC** Characteristics

 $(V_{CC}$  = 2.7 V to 3.6 V, Ta = 0 to 70캜)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to $V_{CC}$	_	_	10	μΑ
Output leakage current	I <sub>LO</sub>	$V_O = 0$ to $V_{CC}$	_	_	10	μΑ
V <sub>CC</sub> power supply current	Iccsc	CE# = V <sub>CC</sub>	CE# = V <sub>CC</sub> —		10	μΑ
(Standby)	I <sub>CCST</sub>	CE# = V <sub>IH</sub>	_	_	1	mA
V <sub>CC</sub> power supply current	1	CE# = V <sub>IL</sub> , OE# = V <sub>IH</sub>			20	mA
(Read)	I <sub>CCA</sub>	f=5MHz	_	_	20	IIIA
Input "H" level	$V_{IH}$	_	2.2	_	V <sub>CC</sub> +0.5*	V
Input "L" level	V <sub>IL</sub>	<del>_</del>	-0.5**	_	0.6	V
Output "H" level	VoH	I <sub>OH</sub> = -1 mA	2.4	_	_	V
Output "L" level	V <sub>OL</sub>	I <sub>OL</sub> = 2 mA	_	_	0.4	V

# Voltage is relative to $V_{SS}$ .

<sup>\* :</sup> Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.

<sup>\*\*: -1.5</sup>V(Min.) when pulse width of undershoot is less than 10ns.

#### **AC Characteristics**

 $(V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}, \text{ Ta} = 0 \text{ to } 70 \text{ } \text{\text{\text{$\geq}}})$ 

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	tc	_	90	_	ns
Address access time	t <sub>ACC</sub>	CE# = OE# = V <sub>IL</sub>	_	90	ns
CE# access time	t <sub>CE</sub>	OE# = V <sub>IL</sub>	_	90	ns
OE# access time	t <sub>OE</sub>	CE# = V <sub>IL</sub>	_	30	ns
Output disable time	t <sub>CHZ</sub>	OE# = V <sub>IL</sub>	0	30	ns
Output disable time	tonz	CE# = V <sub>IL</sub>	0	25	ns
Output hold time	t <sub>OH</sub>	CE# = OE# = V <sub>IL</sub>	0	_	ns

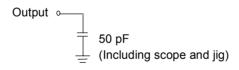
 $(V_{CC}$  = 3.0 V to 3.6 V, Ta = 0 to 70캜)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t <sub>C</sub>	<del>-</del>	80	_	ns
Address access time	t <sub>ACC</sub>	CE# = OE# = V <sub>IL</sub>	_	80	ns
CE# access time	t <sub>CE</sub>	OE# = V <sub>IL</sub>	_	80	ns
OE# access time	toE	CE# = V <sub>IL</sub>	_	30	ns
Output diaable time	t <sub>CHZ</sub>	OE# = V <sub>IL</sub>	0	20	ns
Output disable time	t <sub>OHZ</sub>	CE# = V <sub>IL</sub>	0	20	ns
Output hold time	tон	CE# = OE# = V <sub>IL</sub>	0	_	ns

#### Measurement conditions

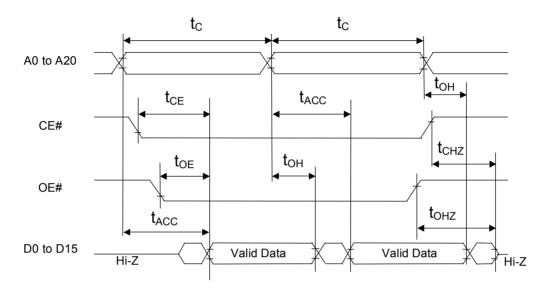
Input signal level------ 0 V/3 V
Input timing reference level------ 1/2Vcc
Output load ------ 50 pF
Output timing reference level------ 1/2Vcc

### Output load

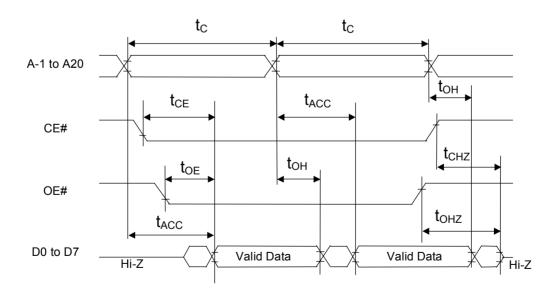


# **TIMING CHART (READ CYCLE)**

# 16-Bit Read Mode (BYTE# = V<sub>IH</sub>)

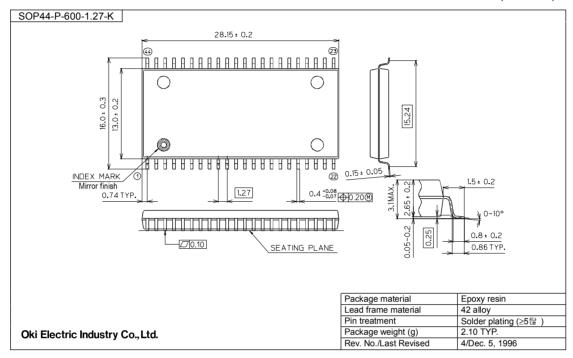


# 8-Bit Read Mode (BYTE# = V<sub>IL</sub>)



#### **PACKAGE DIMENSIONS**

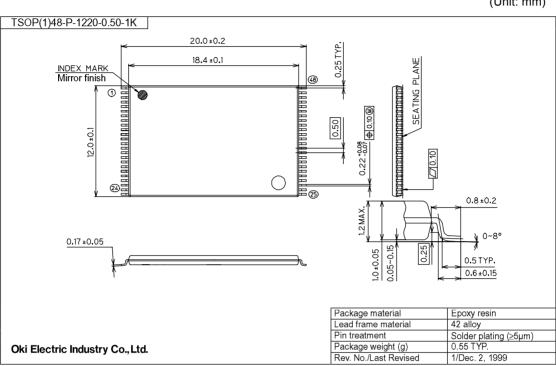




Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).



(Unit: mm)

Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

# **REVISION HISTORY**

Document		Pa	ıge	
No.	Date	Previous Edition	Current Edition	Description
FEDR27T3202L-02-01	Mar. 1, 2005	_	_	Final edition 1
FEDR27T3202L-02-02	Jul. 11, 2005	1	1, 7, 8	Add MR27T3202L-xxxMA

#### **NOTICE**

- 1. The information contained herein can change without notice owing to product and/or technical improvements. Before using the product, please make sure that the information being referred to is up-to-date.
- 2. The outline of action and examples for application circuits described herein have been chosen as an explanation for the standard action and performance of the product. When planning to use the product, please ensure that the external conditions are reflected in the actual circuit, assembly, and program designs.
- 3. When designing your product, please use our product below the specified maximum ratings and within the specified operating ranges including, but not limited to, operating voltage, power dissipation, and operating temperature.
- 4. Oki assumes no responsibility or liability whatsoever for any failure or unusual or unexpected operation resulting from misuse, neglect, improper installation, repair, alteration or accident, improper handling, or unusual physical or electrical stress including, but not limited to, exposure to parameters beyond the specified maximum ratings or operation outside the specified operating range.
- 5. Neither indemnity against nor license of a third party's industrial and intellectual property right, etc. is granted by us in connection with the use of the product and/or the information and drawings contained herein. No responsibility is assumed by us for any infringement of a third party's right which may result from the use thereof.
- 6. The products listed in this document are intended for use in general electronics equipment for commercial applications (e.g., office automation, communication equipment, measurement equipment, consumer electronics, etc.). These products are not authorized for use in any system or application that requires special or enhanced quality and reliability characteristics nor in any system or application where the failure of such system or application may result in the loss or damage of property, or death or injury to humans. Such applications include, but are not limited to, traffic and automotive equipment, safety devices, aerospace equipment, nuclear power control, medical equipment, and life-support systems.
- 7. Certain products in this document may need government approval before they can be exported to particular countries. The purchaser assumes the responsibility of determining the legality of export of these products and will take appropriate and necessary steps at their own expense for these.
- 8. No part of the contents contained herein may be reprinted or reproduced without our prior permission.

Copyright 2005 Oki Electric Industry Co., Ltd.